

MR2400F-MR2406F

24A FAST RECOVERY RECTIFIERS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	MR					Unit
		2400F	2401F	2402F	2404F	2406F	
Peak repetitive reverse voltage	V_{RRM}						V
Working peak reverse voltage	V_{RWM}	50	100	200	400	600	
DC blocking voltage	V_R						
Non-repetitive peak reverse voltage	V_{RSM}	75	150	250	450	650	V
RMS reverse voltage	$V_{R(RMS)}$	35	70	140	280	420	V
Average rectified forward current (single phase, resistive load, $T_C = 125^\circ\text{C}$)	I_O	24					A
Non repetitive peak surge current (@ rated load)	I_{FSM}	300					A
Operating junction temperature range	T_J	-65 to +150					$^\circ\text{C}$
Storage junction temperature range	T_{stg}	-65 to +175					$^\circ\text{C}$
Thermal resistance, junction to case	$R_{\theta JC}$	0.8					$^\circ\text{C}/\text{W}$
Thermal resistance, junction to air, (PC board mount, perpendicular to surface)	$R_{\theta JA}$	55					$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

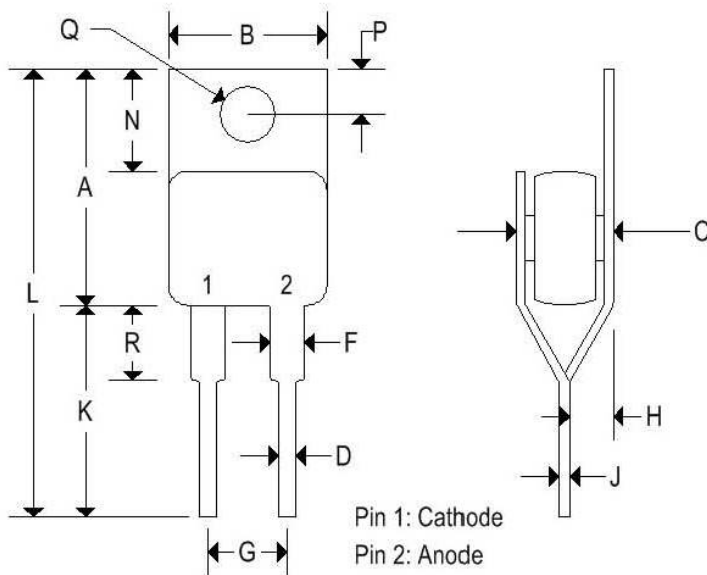
Parameter	Symbol	Min	Typ	Max	Unit
Instantaneous forward voltage ($I_F = 75\text{A}$, $T_J = 150^\circ\text{C}$)	V_F	-	1.15	1.29	V
Forward voltage ($I_F = 24\text{A}$, $T_C = 25^\circ\text{C}$)	V_F	-	1.00	1.15	V
Reverse current (Rated dc voltage, $T_C = 25^\circ\text{C}$)	I_R	-	10	25	μA
(Rated dc voltage, $T_C = 100^\circ\text{C}$)		-	0.5	1.0	mA
(Rated dc voltage, $T_C = 150^\circ\text{C}$)		-	7.0	10	mA
Reverse recovery time – soft recovery ($I_F = 1.0\text{A}$ to $V_R = 30\text{Vdc}$) ($I_{FM} = 36\text{A}$, $di/dt = 25\text{A}/\mu\text{s}$)	t_{rr}	-	150 200	200 300	ns
Reverse recovery current ($I_F = 1.0\text{A}$ to $V_R = 30\text{Vdc}$)	$I_{RM(REC)}$	-	-	4.0	A

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MECHANICAL CHARACTERISTICS

Case	Digi AA
Marking	Body painted, alpha-numeric
Pin out	See below



	Digi AA			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.560	0.625	14.220	15.88
B	0.380	0.420	9.650	10.670
C	0.284	0.310	7.210	7.870
D	0.025	0.045	0.640	1.140
F	0.060	0.090	1.520	2.290
G	0.170	0.210	4.320	5.330
H	0.080	0.115	2.030	2.920
J	0.023	0.029	0.580	0.740
K	-	0.562	-	14.270
L	-	1.187	-	30.150
N	0.230	0.270	5.840	6.860
P	0.100	0.120	2.5400	3.050
Q	0.139	0.147	3.530	3.730
R	-	0.200	-	5.080

FIGURE 1 — MAXIMUM FORWARD VOLTAGE

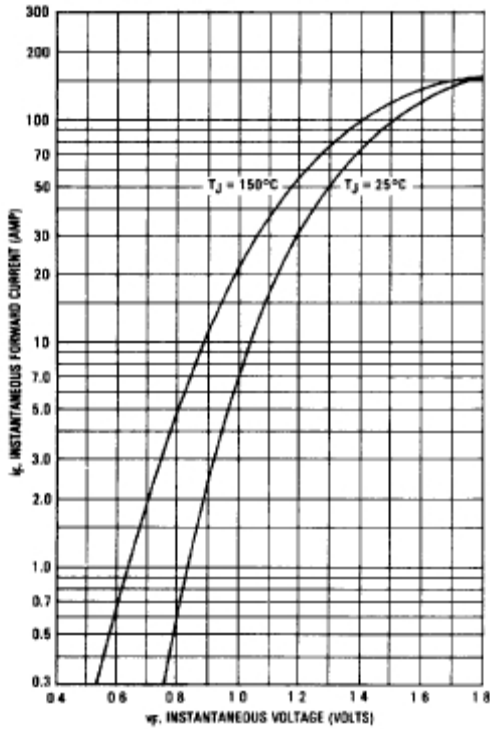
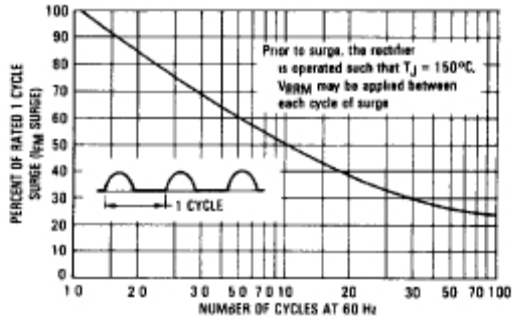



FIGURE 2 — MAXIMUM SURGE CAPABILITY



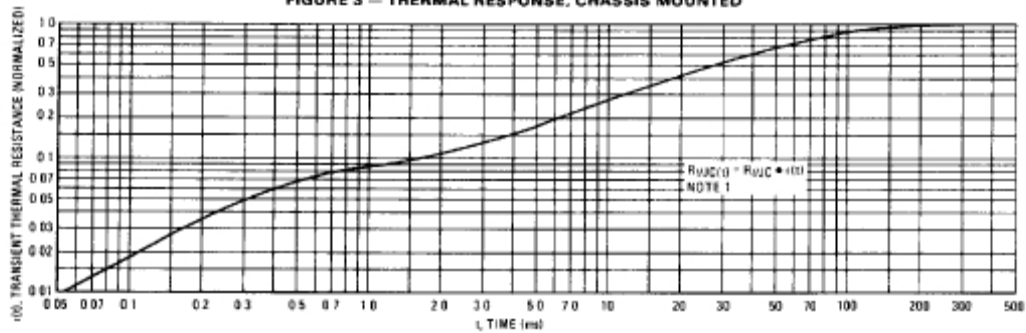
NOTE 1



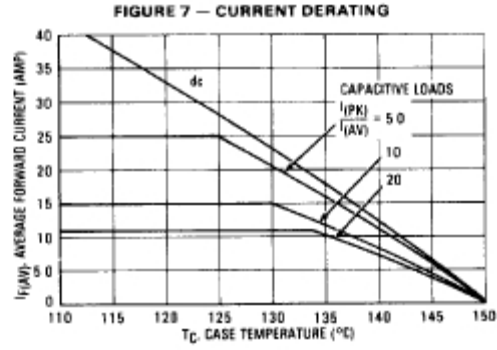
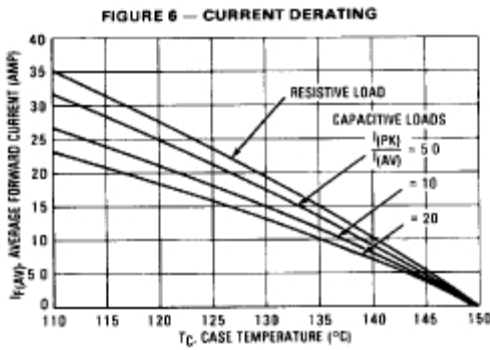
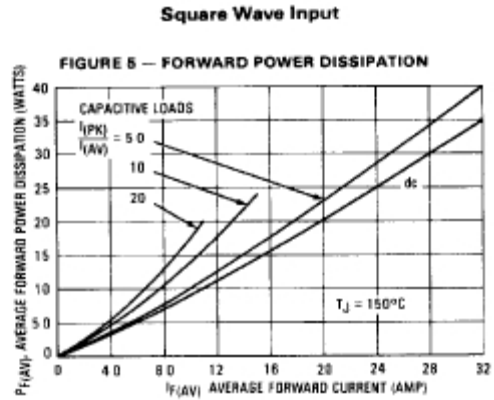
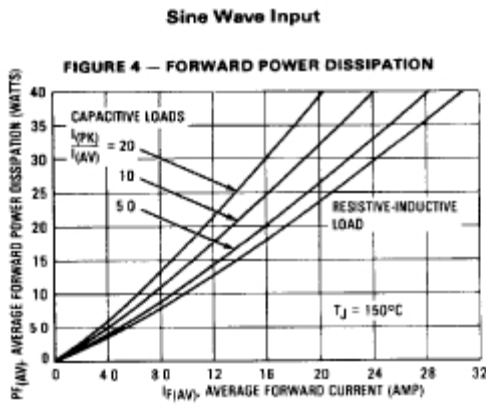
DUTY CYCLE, $D = t_p/t_1$
PEAK POWER, P_{pk} , is peak of an equivalent square power pulse
Time

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:
The temperature of the case should be measured using a thermocouple placed on the case at the temperature reference point. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:
$$T_J = T_C + \Delta T_{JC}$$
where ΔT_{JC} is the increase in junction temperature above the case temperature. It may be determined by:
$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_1)]$$
where
 $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 3, i.e.
 $r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$

FIGURE 3 — THERMAL RESPONSE, CHASSIS MOUNTED



CHASSIS MOUNT RATING DATA



PRINTED CIRCUIT BOARD RATING DATA

